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CY2CC810

1:10 Clock Fanout Buffer

Features

- Low-voltage operation
- V_{DD} range from 2.5 V to 3.3 V
- 1:10 fanout
- Over voltage tolerant input hot swappable
- Drives either a 50-Ohm or 75-Ohm transmission line
- Low-input capacitance
- 250 ps typical output-to-output skew
- 19 ps typical DJ jitter
- Typical propagation delay < 3.5 ns</p>
- High-speed operation > 500 MHz
- Industrial temperature range
- Available packages include: SSOP

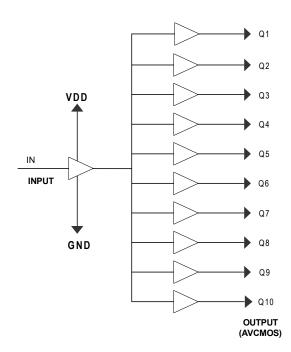
Logic Block Diagram

Functional Description

The Cypress series of network circuits are produced using advanced 0.35-micron CMOS technology, achieving the industry's fastest logic and buffers.

The Cypress CY2CC810 fanout buffer features one input and ten outputs. Designed for data communications clock management applications, the large fanout from a single input reduces loading on the input clock.

For a complete list of related documentation, click here.



Cypress Semiconductor Corporation Document Number: 38-07056 Rev. *J 198 Champion Court

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San Jose, CA 95134-1709

• 408-943-2600 Revised May 5, 2016



CY2CC810

Contents

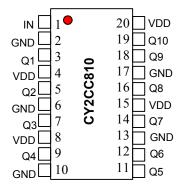
Pin Configuration	3
Pin Description	
Absolute Maximum Conditions	4
DC Electrical Characteristics	4
DC Electrical Characteristics	5
Capacitance	5
Thermal Resistance	
Power Supply Characteristics	
High-frequency Parametrics	
AC Switching Characteristics	
AC Switching Characteristics	
Parameter Measurement Information	
Parameter Measurement Information	

Ordering Information	11
Ordering Code Definitions	11
Package Drawing and Dimensions	12
Acronym	13
Document Conventions	13
Units of Measure	
Document History Page	14
Sales, Solutions, and Legal Information	15
Worldwide Sales and Design Support	15
Products	15
PSoC®Solutions	
Cypress Developer Community	
Technical Support	



Pin Configuration

Figure 1. 20-pin SSOP pinout



20 pin SOIC/SSOP

Pin Description

Pin Number	Pin Name	Description			
1	IN	Input	LVCMOS		
2, 6, 10, 13, 17	GND	Ground	Power		
4, 8, 15, 20	V _{DD}	Power Supply	Power		
3, 5, 7, 9, 11, 12, 14, 16, 18, 19	Q1 Q10	Output	AVCMOS		



Absolute Maximum Conditions

Parameter ^[1, 2]	Description	Min	Max	Unit
V _{DD}	V _{DD} ground supply voltage	-0.5	4.6	V
V _{IN}	Input supply voltage to ground potential	-0.5	5.8	V
V _{OUT}	Output supply voltage to ground potential	-0.5	V _{DD} + 1	V
Τ _S	Temperature, storage	-65	150	°C
T _A	Temperature, operating ambient	-40	85	°C
	Power dissipation	0.75		W

DC Electrical Characteristics

@ 3.3 V (see Figure 6)

Parameter	Description	Conditior	ıs	Min	Тур	Max	Unit
V _{OH}	Output high voltage	V_{DD} = Min, V_{IN} = V_{IH} or V_{IL}	I _{OH} = –12 mA	2.3	3.3	_	V
V _{OL}	Output low voltage	V _{DD} = Min, V _{IN} = V _{IH} or V _{IL}	I _{OL} = 12 mA	-	0.2	0.5	V
V _{IH}	Input high voltage	Guaranteed Logic High Level	-	2	-	5.8	V
V _{IL}	Input low voltage	Guaranteed Logic Low Level	-	-	-	0.8	V
I _{IH}	Input high current	V _{DD} = Max	V _{IN} = 2.7 V	-	-	1	μA
IIL	Input low current	V _{DD} = Max	V _{IN} = 0.5 V	_	_	-1	μA
I _I	Input high current	V _{DD} = Max, V _{IN} = V _{DD} (Max)	-	-	-	20	μΑ
V _{IK}	Clamp diode voltage	V_{DD} = Min, I_{IN} = -18 mA	-	-	-0.7	-1.2	V
I _{OK}	Continuous clamp current	V _{DD} = Max, V _{OUT} = GND	-	-	-	-50	mA
O _{OFF}	Power down disable	V _{DD} = GND, V _{OUT} ≤ 4.5 V	-	-	-	100	μΑ
V _H	Input hysteresis	V_{DD} = Min, V_{IN} = V_{IH} or V_{IL}	-	-	80		mV

Notes

Stresses greater than those listed under absolute maximum ratings may cause permanent damage to the device. This is intended to be a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
 Multiple Supplies: The voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.



DC Electrical Characteristics

@ 2.5 V (see Figure 2)

Parameter	Description	Condition	ns	Min	Тур	Мах	Unit
V _{OH}	Output high voltage	V _{DD} = Min,	I _{OH} = -7 mA	1.8	-	-	V
		$V_{IN}^{DD} = V_{IH}$ or V_{IL}	I _{OH} = 12 mA	1.6	-	-	V
V _{OL}	Output low voltage	V _{DD} = Min, V _{IN} = V _{IH} or V _{IL}	I _{OL} = 12 mA		-	0.65	V
V _{IH}	Input high voltage	Guaranteed Logic High Level	_	1.6	-	5.0	V
V _{IL}	Input low voltage	Guaranteed Logic Low Level	_	-	-	0.8	V
I _{IH}	Input high current	V _{DD} = Max	V _{IN} = 2.4 V	-	-	1	μΑ
IIL	Input low current	V _{DD} = Max	V _{IN} = 0.5 V	-	-	–1	μΑ
l _l	Input high current	V _{DD} = Max, V _{IN} = V _{DD} (Max)	-	-	-	20	μA
V _{IK}	Clamp diode voltage	V_{DD} = Min, I_{IN} = -18 mA	-	-	-0.7	-1.2	V
I _{ОК}	Continuous clamp current	V _{DD} = Max, V _{OUT} = GND	_	-	-	-50	mA
O _{OFF}	Power-down disable	V _{DD} = GND, V _{OUT} ≤ 4.5 V	-	_	-	100	μΑ
V _H	Input hysteresis	_	_	_	80	_	mV

Capacitance

Parameter	Description	Test Conditions	Min	Тур	Мах	Unit
Cin	Input capacitance	V _{IN} = 0 V	_	2.5	_	pF
Cout	Output capacitance	V _{OUT} = 0 V	_	6.5	-	pF

Thermal Resistance

Parameter ^[3]	Description	Test Conditions	20-pin SSOP	Unit
θ_{JA}		Test conditions follow standard test methods and procedures for measuring thermal impedance, in	-	°C/W
θ _{JC}	Thermal resistance (junction to case)	accordance with EIA/JESD51.	35	°C/W

Note
3. These parameters are guaranteed by design and are not tested.



Power Supply Characteristics

(see Figure 6)

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
Δ _{ICC}	Delta I _{CC} quiescent power supply current	$(I_{DD} @ V_{DD} = Max and V_{IN} = V_{DD}) - (I_{DD} @ V_{DD} = Max and V_{IN} = V_{DD} - 0.6 V)$	-	-	50	μA
I _{CCD}		V _{DD} = Max Input toggling 50% Duty Cycle, Outputs Open	-		0.63	mA/ MHz
lc		V _{DD} = Max Input toggling 50% Duty Cycle, Outputs Open fL = 40 MHz	-	_	25	mA
t _{PU}	Power-up time for all V _{DD} s	Power-up to reach minimum specified voltage (power ramp must be monotonic)	0.05	Ι	500	ms

High-frequency Parametrics

Parameter	Description	Test Conditions		Min	Тур	Max	Unit
Dj	Jitter, Deterministic	50% duty cycle t _W (50–50)	2.5 V	_	23	35	ps
		The "point to point load circuit" Output Jitter – Input Jitter	3.3 V	-	19	30	ps
F _{max(3.3 V)}	Maximum frequency V _{DD} = 3.3 V	50% duty cycle t _W (50–50) Standard Load Circuit.	See Figure 6	-	-	160	MHz
		50% duty cycle t _W (50–50) The "point to point load circuit"	See Figure 8	-	-	650	
F _{max(2.5 V}	Maximum frequency V _{DD} = 2.5 V	The "point to point load circuit" V _{IN} = 2.4 V/0.0 V V _{OUT} = 1.7 V/0.7 V	See Figure 8	_	-	200	MHz
F _{max(20)}	Maximum frequency V _{DD} = 3.3 V	20% duty cycle $t_W(20-80)$ The "point to point load circuit" $V_{IN} = 3.0 V/0.0 V$ $V_{OUT} = 2.3 V/0.4 V$	See Figure 8	-	_	250	MHz
	Maximum frequency V _{DD} = 2.5 V	The "point to point load circuit" V _{IN} = 2.4 V/0.0 V V _{OUT} = 1.7 V/0.7 V	See Figure 4	-	-	200	MHz
t _W	Minimum pulse V _{DD} = 3.3 V	The "point to point load circuit" $V_{IN} = 3.0 \text{ V}/0.0 \text{ V}$ F = 100 MHz $V_{OUT} = 2.0 \text{ V}/0.8 \text{ V}$	See Figure 8	1	_	-	ns
	Minimum pulse V _{DD} = 2.5 V	The "point to point load circuit" $V_{IN} = 2.4 V/0.0 V$ F = 100 MHz $V_{OUT} = 1.7 V/0.7 V$	See Figure 4	1	_	_	



AC Switching Characteristics

@ 3.3 V, V_{DD} = 3.3 V ± 5%, Temperature = –40 °C to +85 °C

Parameter	Description		Min	Тур	Мах	Unit
t _{PLH}	Propagation delay – Low to High	See Figure 5	1.5	2.7	3.5	ns
t _{PHL}	Propagation delay – High to Low		1.5	2.7	3.5	ns
t _R	Output rise time	-	-	0.8	-	V/ns
t _F	Output fall time	-	-	0.8	-	V/ns
t _{SK(0)}	Output Skew: Skew between outputs of the same package (in phase)	See Figure 11	-	0.25	0.38	ns
t _{SK(p)}	Pulse Skew: Skew between opposite transitions of the same output $(t_{PHL} - t_{PLH})$.	See Figure 10	-	-	0.2	ns
t _{SK(t)}	Package Skew: Skew between outputs of different packages at the same power supply voltage, temperature and package type.	See Figure 12	-	-	0.42	ns

AC Switching Characteristics

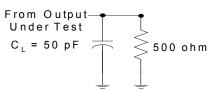
Parameter	Description			Тур	Max	Unit
t _{PLH}	Propagation delay – Low to High	See Figure 5	1.5	2.0	3.5	ns
t _{PHL}	Propagation delay – High to Low		1.5	2.0	3.5	ns
t _R	Output rise time	-	-	0.8	-	V/ns
t _F	Output fall time	-	-	0.8	-	V/ns
t _{SK(0)}	Output Skew: Skew between outputs of the same package (in phase)	See Figure 11	-	0.25	0.38	ns
t _{SK(p)}	Pulse Skew: Skew between opposite transitions of the same output $(t_{PHL} - t_{PLH})$.	See Figure 10	-	-	0.4	ns
t _{SK(t)}	Package Skew: Skew between outputs of different packages at the same power supply voltage, temperature and package type.	See Figure 12	Ι		0.65	ns



Parameter Measurement Information

V_{DD} @ 2.5 V

Figure 2. Load Circuit ^[4, 5, 6]





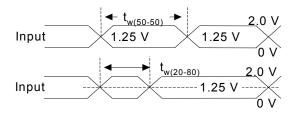


Figure 4. Point to Point Load Circuit ^[4, 5, 6]

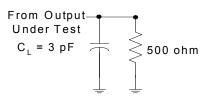
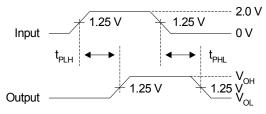


Figure 5. Voltage Waveforms Propagation Delay Times ^[5]



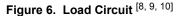
Notes

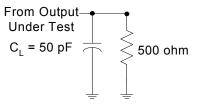
- 4. C_L includes probe and jig capacitance.
- 5. All input pulses are supplied by generators having the following characteristics: PRR < 100 MHz, Z_0 = 50W, t_R < 2.5 nS, t_F < 2.5 nS.
- 6. The outputs are measured one at a time with one transition per measurement.
- 7. T_{PLH} and T_{PHL} are the same as t_{pd} .



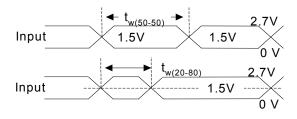
Parameter Measurement Information

V_{DD} @ 3.3 V











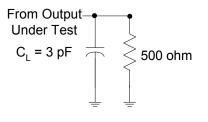
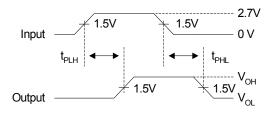


Figure 9. Voltage Waveforms Propagation Delay Times ^[9]



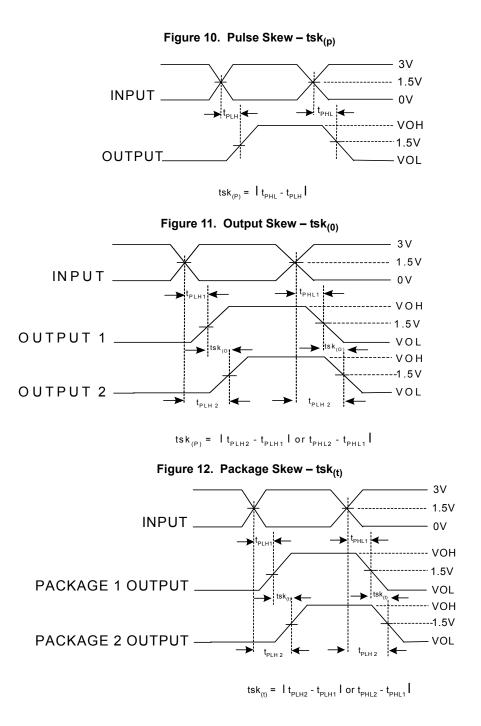
Notes

- C_L includes probe and jig capacitance.
 All input pulses are supplied by generators having the following characteristics: PRR < 100 MHz, Z₀ = 50W, t_R < 2.5 nS, t_F < 2.5 nS.
 The outputs are measured one at a time with one transition per measurement.
- 11. T_{PLH} and T_{PHL} are the same as t_{pd} .



Parameter Measurement Information (Continued)

V_{DD} @ 3.3 V

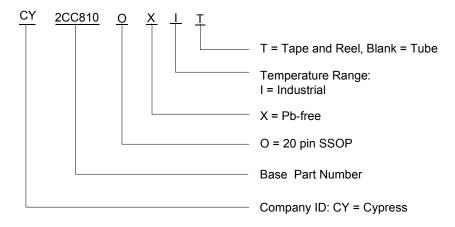




Ordering Information

Part Number ^[12]	Package Type	Product Flow
Pb-free		
CY2CC810OXI	20-pin SSOP	Industrial, –40 °C to 85 °C
CY2CC810OXIT	20-pin SSOP–Tape and Reel	Industrial, –40 °C to 85 °C
CY2CC810OXI-1	20-pin SSOP	Industrial, –40 °C to 85 °C
CY2CC810OXI-1T	20-pin SSOP–Tape and Reel	Industrial, –40 °C to 85 °C

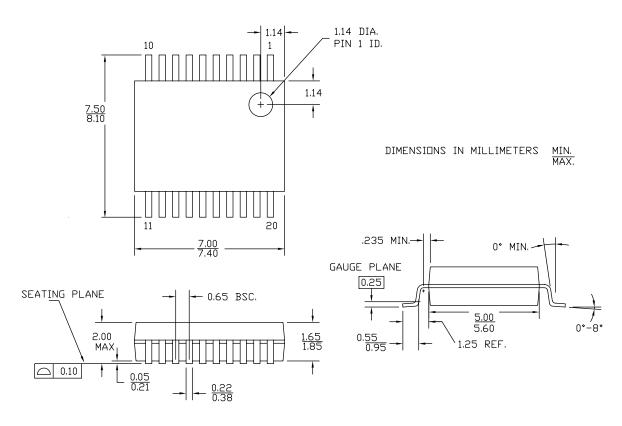
Ordering Code Definitions





Package Drawing and Dimensions

Figure 13. 20-pin SSOP (210 Mils) O20.21 Package Outline, 51-85077



51-85077 *F



Acronym

Acronym	Description
CMOS	complementary metal oxide semiconductor
DJ	Deterministic Jitter
SSOP	shrunk small outline package

Document Conventions

Units of Measure

Symbol	Unit of Measure
°C	degree Celsius
MHZ	megahertz
uA	microampere
mA	milliampere
ms	millisecond
ns	nanosecond
%	percent
pF	picofarad
ps	picosecond
V	volt



Document History Page

Rev.	ECN No.	Submission Date	Orig. of Change	Description of Change
**	107081	06/07/01	IKA	Convert from IMI to Cypress
*A	114315	05/09/02	TSM	∆ I _{DD} Validation
*В	119117	10/07/02	RGL	Updated DC Electrical Characteristics (@ 3.3 V): Added 5.8 V as the maximum value of V_{IH} parameter. Updated DC Electrical Characteristics (@ 2.5 V): Changed maximum value of V_{IH} parameter from 1.8 V to 5.0 V.
*C	122743	12/14/02	RBI	Updated Absolute Maximum Conditions: Added Note 2 (power-up requirements) and referred the same note in "Parameter" column.
*D	387761	See ECN	RGL	Updated High-frequency Parametrics: Updated details in "Test Conditions" column corresponding to D_J parameter Updated values of D_J parameter. Updated AC Switching Characteristics: Updated values of $t_{SK(0)}$, $t_{SK(p)}$, $t_{SK(t)}$ parameters. Updated AC Switching Characteristics: Updated AC Switching Characteristics: Updated Values of $t_{SK(0)}$, $t_{SK(p)}$, $t_{SK(t)}$ parameters. Updated values of $t_{SK(0)}$, $t_{SK(p)}$, $t_{SK(t)}$ parameters. Updated Ordering Information: Removed devices with SOIC package. Added devices Lead-free SSOP package.
*E	499991	See ECN	RGL	Updated Power Supply Characteristics: Added t _{PU} parameter and its details.
*F	2896073	03/19/10	CXQ	Removed SOIC package related information in all instances across the document. Updated Ordering Information: Removed obsolete parts. Added CY2CC810OXI-1, CY2CC810OXI-1T parts. Updated Package Drawing and Dimensions.
*G	3056154	10/08/2010	CXQ	Updated Ordering Information: Removed CY2CC810OXC and CY2CC810OXCT parts.
*H	3396159	10/10/2011	PURU	Updated Functional Description: Removed "AVCMOS-type outputs dynamically adjust for variable impedance matching and reduce noise overall". Added Ordering Code Definitions under Ordering Information. Updated Package Drawing and Dimensions. Added Acronym, and Units of Measure.
*	4559526	11/07/2014	PURU	Updated Functional Description: Added "For a complete list of related documentation, click here." at the end
*J	5272946	05/16/2016	PSR	Added Thermal Resistance. Updated Package Drawing and Dimensions: spec 51-85077 – Changed revision from *E to *F. Updated to new template.



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